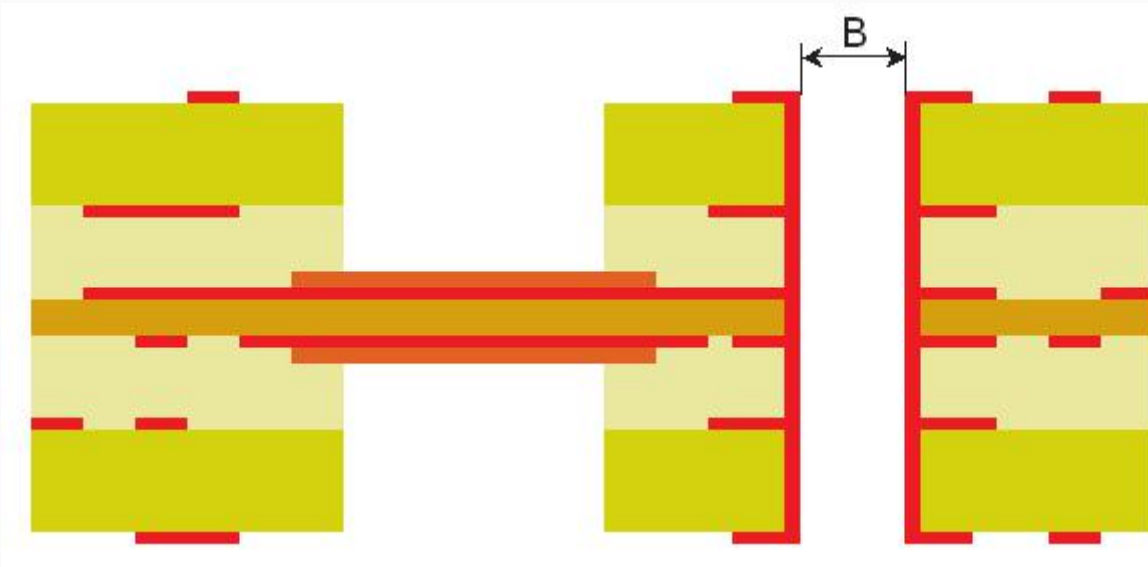


RIGID-FLEX DESIGN RULES

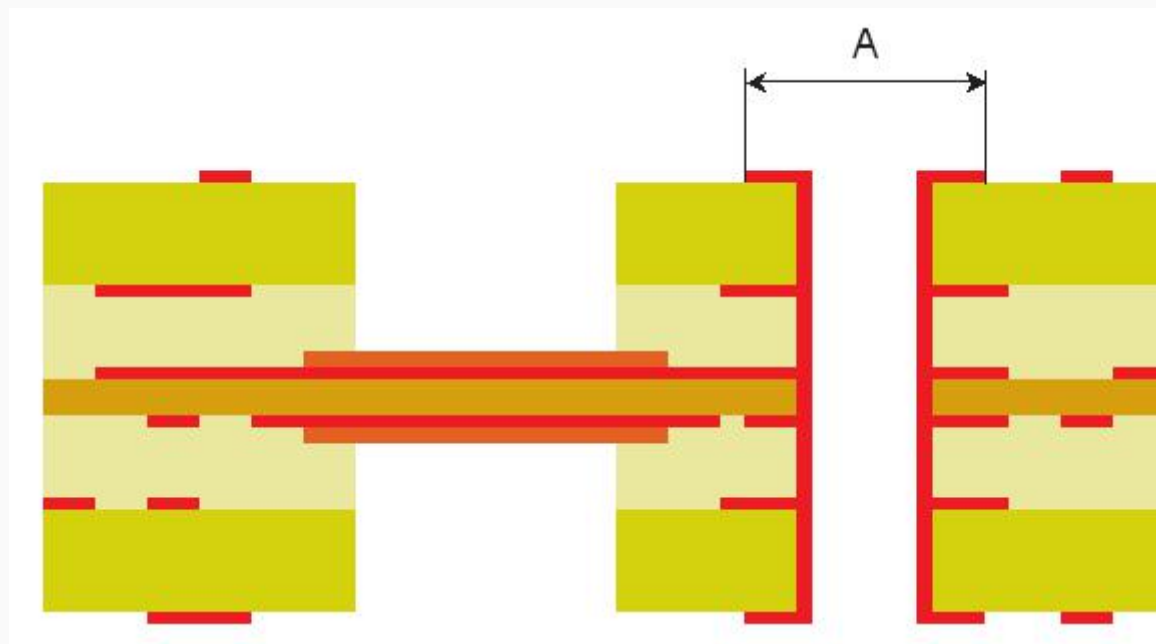
According IPC-6013

Last update: 2016-11-17

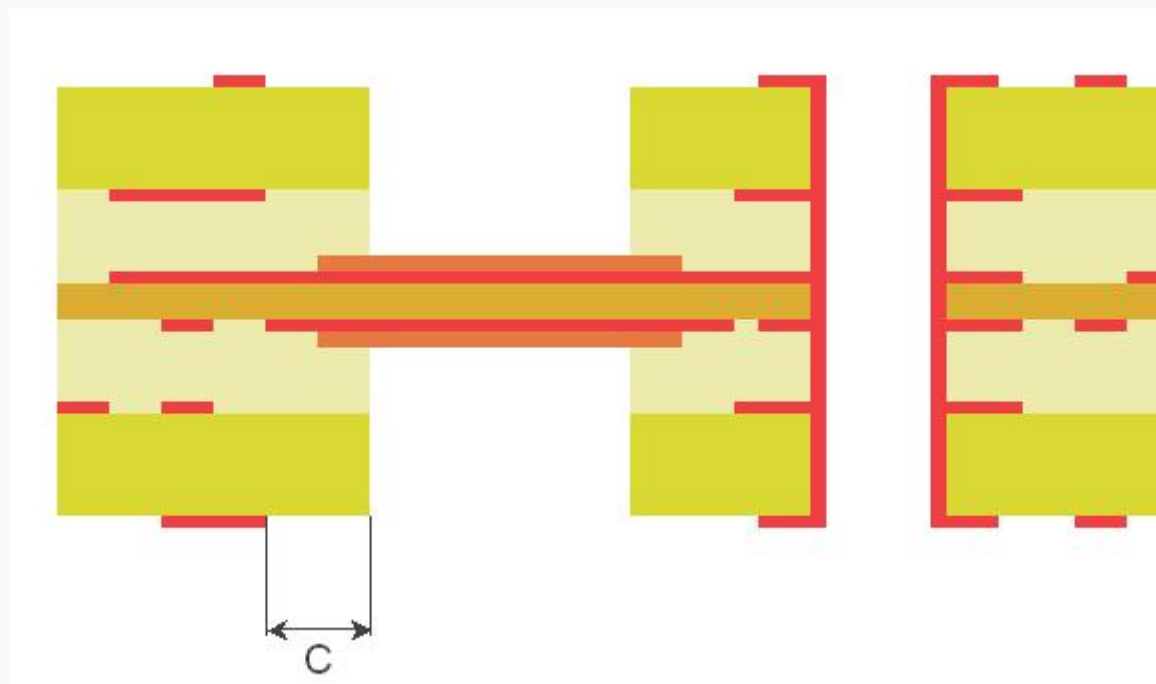
Units: Milimeters

Description	
minimum plated through hole B	

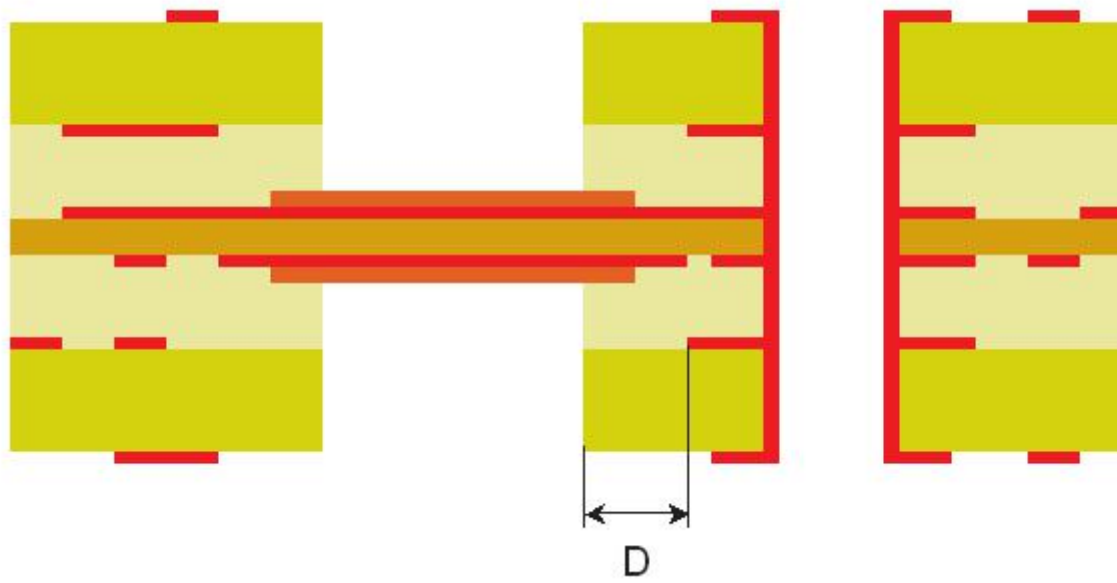
**minimum
pad
diameter A**



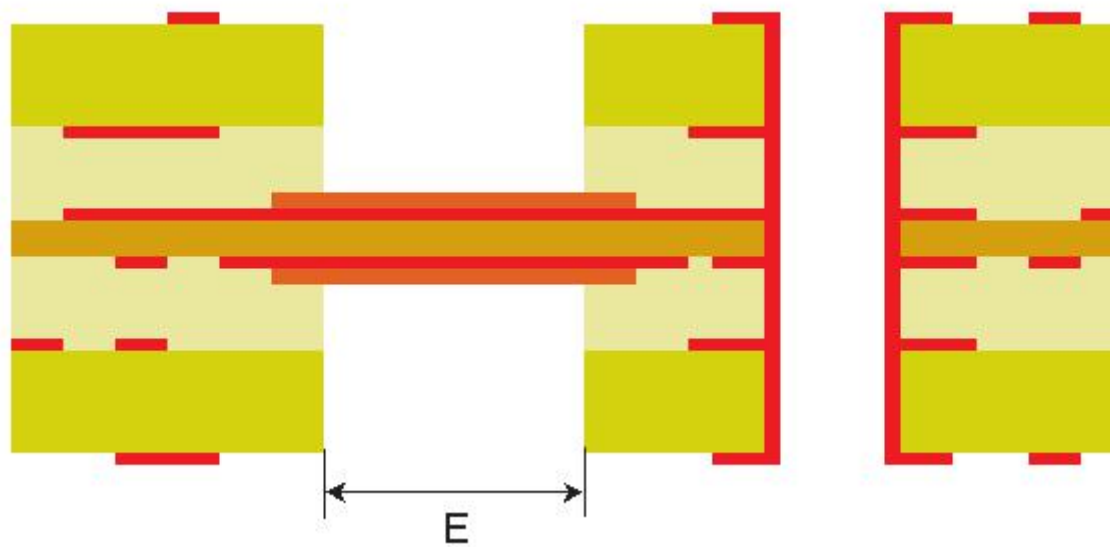
**Copper
distance to
Rigid-flex
intersection**



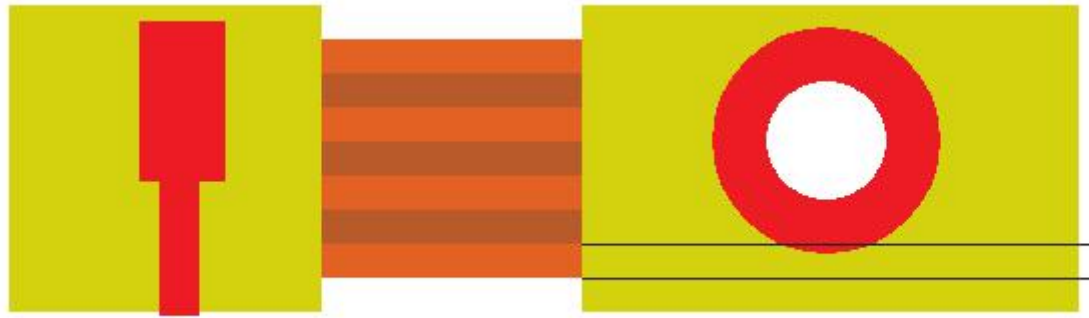
**Copper
distance to
Rigid-flex
intersection**



**minimum
length of
flex area**



**Distance
track-flex
outline**



**minimum
bending
radius**



**max.
quantity of
bending
cycles with
min.
bending
radius**

**Thickness
of flex
material**

**Cu
thickness of
flex layers**

**Thickness
of
coverlayer
IPC-4203/1**

**Max.
number of**

flex layers	
General tolerances	
Maximum PCB size	
Minimum Signal inner layer annular ring	